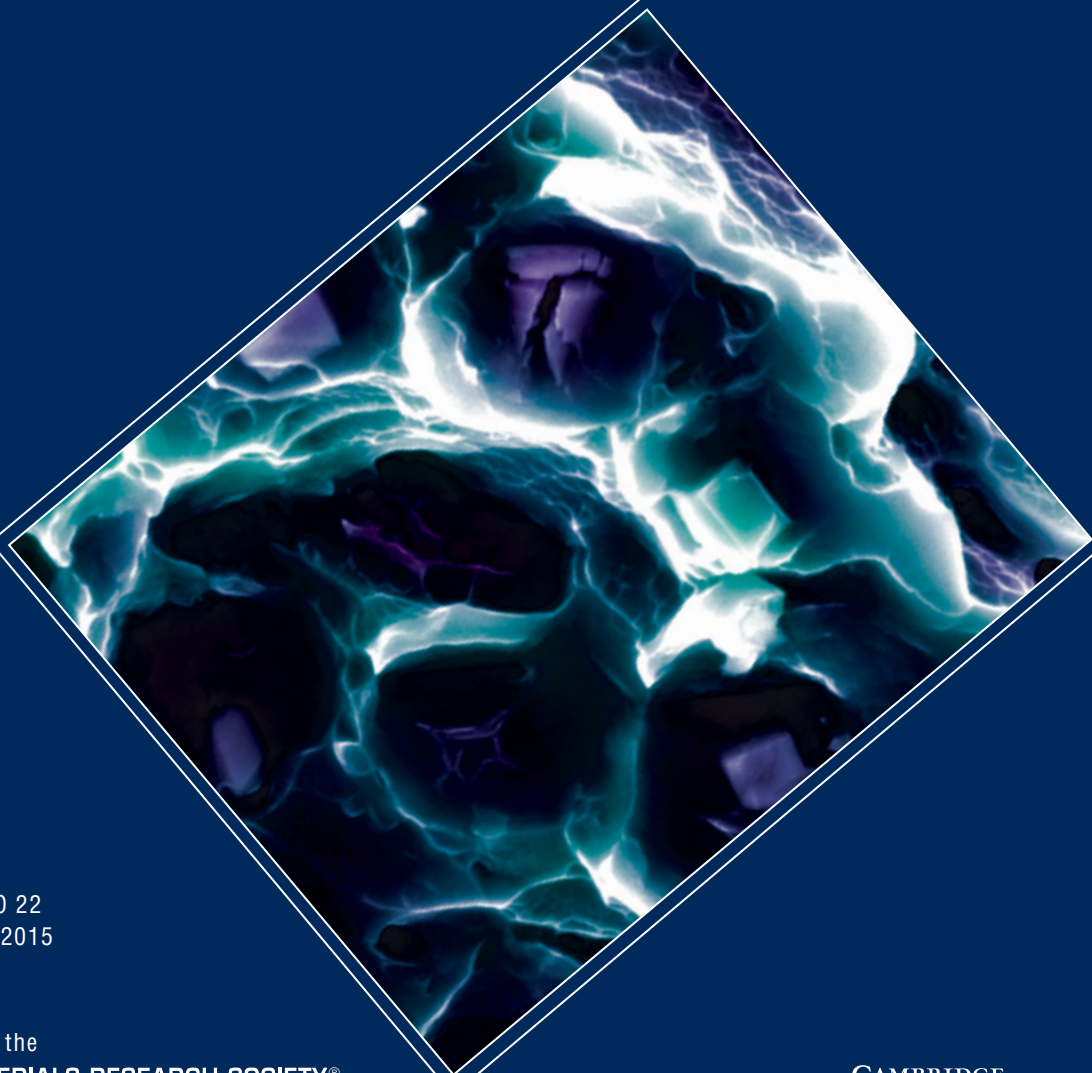


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 **Journal of  
MATERIALS RESEARCH**



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Cover: FIG. 12(d) Enlarged magnification of SEM of tensile fracture surface of sand-cast-T6 Mg–10Gd–3Y–0.3Zr alloys. [Y. Li, G. Wu, A. Chen, H. R. Jafari Nodooshan, W. Liu, Y. Wang, W. Ding: Effects of Gd and Zr additions on the microstructures and high-temperature mechanical behavior of Mg–Gd–Y–Zr magnesium alloys in the product form of a large structural casting. p. 3461].

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